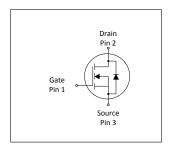


MOSFET

600V CoolMOS™ CFD7 Power Transistor

CoolMOSTM is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. The latest CoolMOSTM CFD7 is the successor to the CoolMOSTM CFD2 series and is an optimized platform tailored to target soft switching applications such as phase-shift full-bridge (ZVS) and LLC. Resulting from reduced gate charge (Qg), best-in-class reverse recovery charge (Qrr) and improved turn off behavior CoolMOSTM CFD7 offers highest efficiency in resonant topologies. As part of Infineon's fast body diode portfolio, this new product series blends all advantages of a fast switching technology together with superior hard commutation robustness, without sacrificing easy implementation in the design-in process. The CoolMOSTM CFD7 technology meets highest efficiency and reliability standards and furthermore supports high power density solutions. Altogether, CoolMOSTM CFD7 makes resonant switching topologies more efficient, more reliable, lighter and cooler.

PG-TO 247-3









Features

- Ultra-fast body diode
- Low gate charge
- Best-in-class reverse recovery charge (Q_{rr})
- Improved MOSFET reverse diode dv/dt and di_F/dt ruggedness
- Lowest FOM R_{DS(on)}*Q_g and R_{DS(on)}*E_{oss}
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- · Excellent hard commutation ruggedness
- Highest reliability for resonant topologies
- Highest efficiency with outstanding ease-of-use / performance tradeoff
- Enabling increased power density solutions

Potential applications

Suiteable for Soft Switching topologies Optimized for phase-shift full-bridge (ZVS), LLC Applications – Server, Telecom, EV Charging

Product Validation: Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

Table 1 Key Performance Parameters

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Parameter	Value	Unit					
V _{DS} @ T _{j,max}	650	V					
R _{DS(on),max}	70	mΩ					
$Q_{g,typ}$	67	nC					
I _{D,pulse}	129	A					
E _{oss} @ 400V	7.7	μJ					
Body diode di _F /dt	1300	A/µs					

Type / Ordering Code	Package	Marking	Related Links
IPW60R070CFD7	PG-TO 247-3	60R070F7	see Appendix A

600V CoolMOS™ CFD7 Power Transistor IPW60R070CFD7



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600V CoolMOS™ CFD7 Power Transistor IPW60R070CFD7



1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Combal		Value	S	Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	31 20	А	T _C =25°C T _C =100°C
Pulsed drain current ²⁾	I _{D,pulse}	-	-	129	Α	T _C =25°C
Avalanche energy, single pulse	E AS	-	-	151	mJ	I _D =6.3A; V _{DD} =50V; see table 10
Avalanche energy, repetitive	E AR	-	-	0.76	mJ	I _D =6.3A; V _{DD} =50V; see table 10
Avalanche current, single pulse	I _{AS}	-	-	6.3	Α	-
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V _{DS} =0400V
Gate source voltage (static)	V _{GS}	-20	-	20	V	static;
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)
Power dissipation	P _{tot}	-	-	156	W	<i>T</i> _C =25°C
Storage temperature	T _{stg}	-55	-	150	°C	-
Operating junction temperature	T _j	-55	-	150	°C	-
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws
Continuous diode forward current	Is	-	-	31	Α	<i>T</i> _C =25°C
Diode pulse current ²⁾	I _{S,pulse}	-	-	129	Α	<i>T</i> _C =25°C
Reverse diode dv/dt ³⁾	dv/dt	-	-	70	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=31A, $T_{\rm j}$ =25°C see table 8
Maximum diode commutation speed	ximum diode commutation speed		$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=31A, $T_{\rm j}$ =25°C see table 8			
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min

 $^{^{1)}}$ Limited by $T_{j,max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

IPW60R070CFD7



2 Thermal characteristics

Table 3 Thermal characteristics

Development	Cumbal	Values			11	Nata / Tank Canadikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	8.0	°C/W	-
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T _{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

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Electrical characteristics

at T_j=25°C, unless otherwise specified

Table 4 **Static characteristics**

Parameter	Ob. a.l		Values	;	Unit	
	Symbol	Min.	Тур.	Max.		Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_D =1mA
Gate threshold voltage	$V_{(GS)th}$	3.5	4	4.5	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =0.76mA
Zero gate voltage drain current ¹⁾	I _{DSS}	-	- 15	1 63	μΑ	V _{DS} =600V, V _{GS} =0V, T _i =25°C V _{DS} =600V, V _{GS} =0V, T _j =125°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.057 0.13	0.07	Ω	V _{GS} =10V, I _D =15.1A, T _i =25°C V _{GS} =10V, I _D =15.1A, T _i =150°C
Gate resistance	R _G	-	5.9	-	Ω	f=1MHz, open drain

Table 5 **Dynamic characteristics**

Danamatan	Or smalls all	Values				Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	2721	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Output capacitance	Coss	-	53	-	pF	V _{GS} =0V, V _{DS} =400V, f=250kHz
Effective output capacitance, energy related ²⁾	C _{o(er)}	-	96	-	pF	V _{GS} =0V, V _{DS} =0400V
Effective output capacitance, time related ³⁾	C _{o(tr)}	-	990	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0400V
Turn-on delay time	$t_{\sf d(on)}$	-	26	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Rise time	t _r	-	23	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	99	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9
Fall time	<i>t</i> f	-	6	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =10V, $I_{\rm D}$ =11.0A, $R_{\rm G}$ =5.3 Ω ; see table 9

Table 6 **Gate charge characteristics**

Dougnatou	Cumbal		Values		Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.		
Gate to source charge	Q_{gs}	-	15	-	nC	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V
Gate to drain charge	$Q_{ m gd}$	-	24	-	nC	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V
Gate charge total	Qg	-	67	-	nC	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V
Gate plateau voltage	V _{plateau}	-	5.5	-	V	V_{DD} =400V, I_{D} =11.0A, V_{GS} =0 to 10V

 $^{^{1)}}$ Maximum specification is defined by calculated six sigma upper confidence bound $^{2)}$ $C_{\rm o(er)}$ is a fixed capacitance that gives the same stored energy as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V $^{3)}$ $C_{\rm o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{\rm oss}$ while $V_{\rm DS}$ is rising from 0 to 400V

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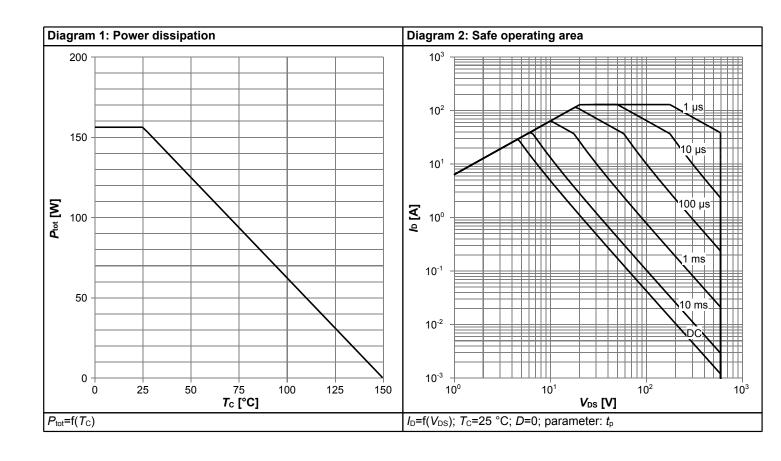


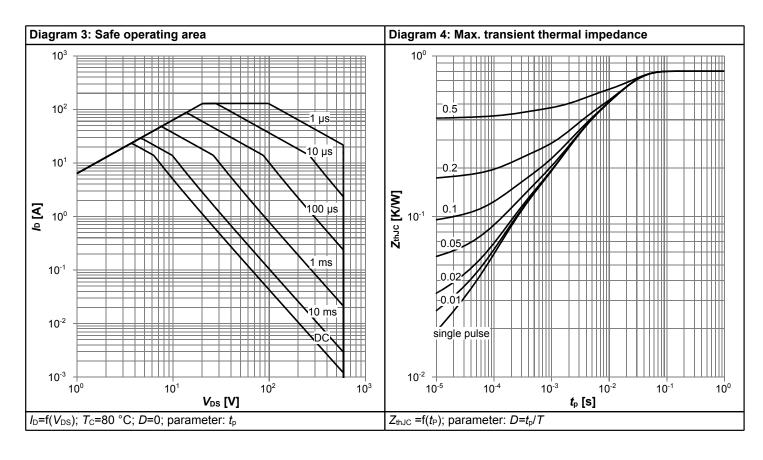
Table 7 Reverse diode characteristics

Parameter	Symbol		Values	i	Unit	Note / Test Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	1.0	-	V	V _{GS} =0V, I _F =15.1A, T _j =25°C
Reverse recovery time	t _{rr}	-	124	186	ns	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	0.57	1.14	μC	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	7.8	-	А	V_R =400V, I_F =11A, di_F/dt =100A/ μ s; see table 8

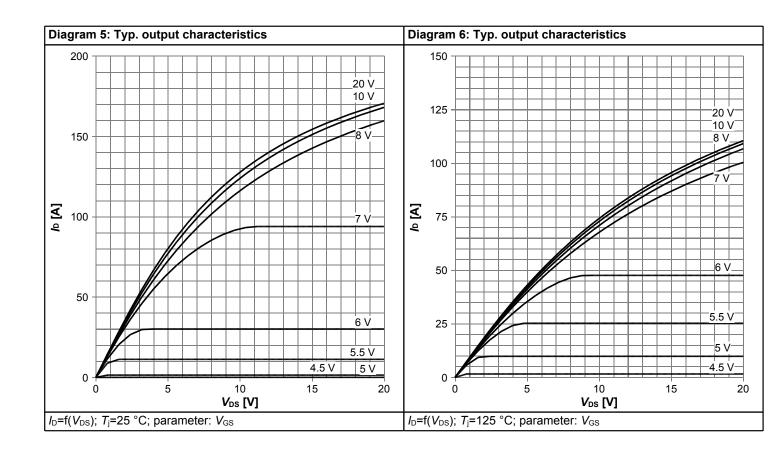


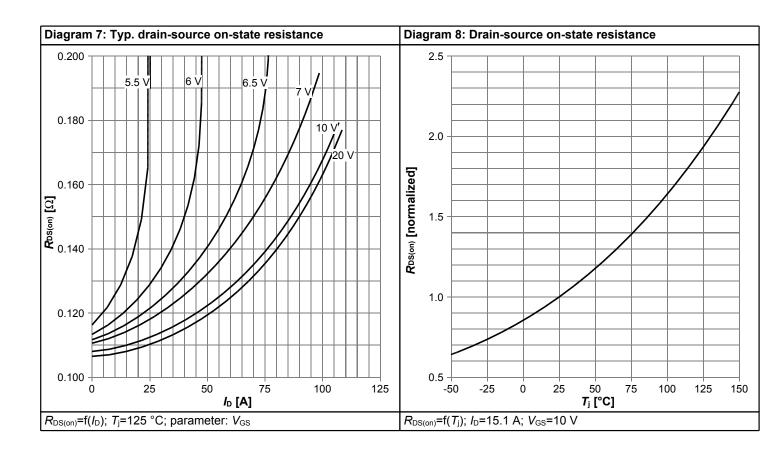
4 Electrical characteristics diagrams



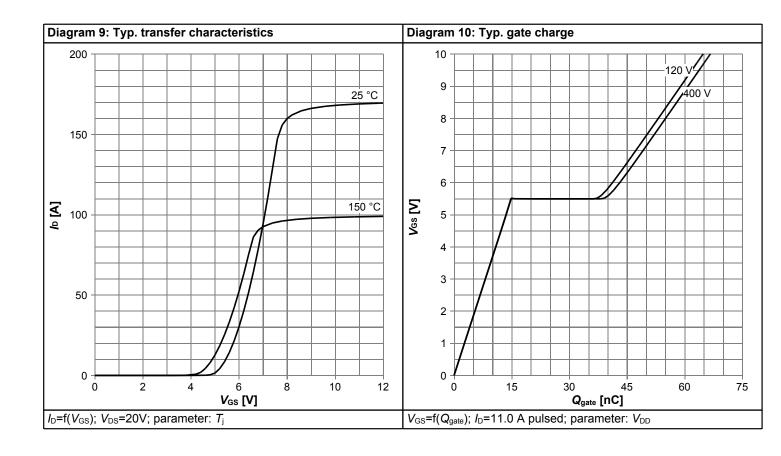


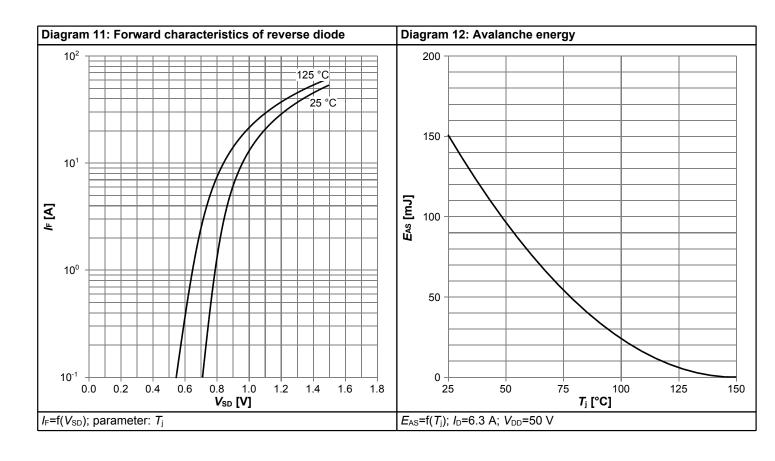




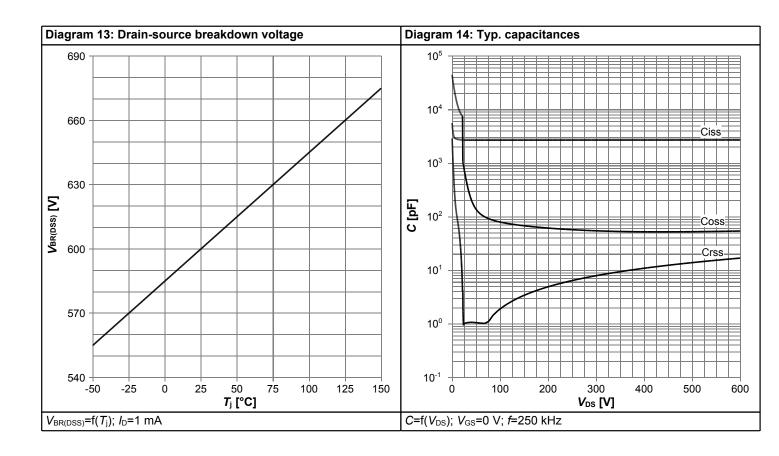


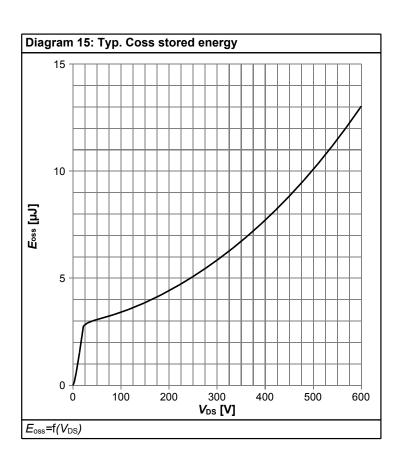














5 Test Circuits

Table 8 Diode characteristics

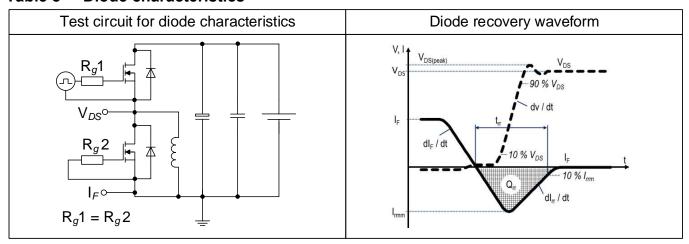
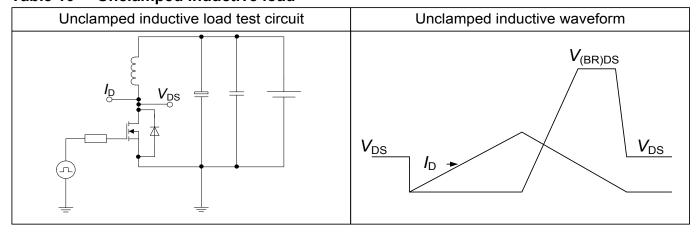


Table 9 Switching times



Table 10 Unclamped inductive load





6 Package Outlines

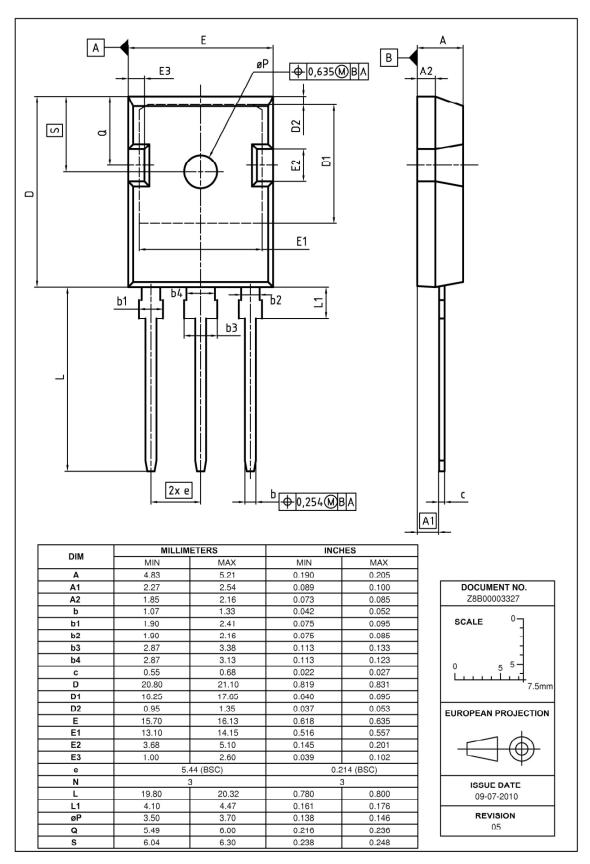


Figure 1 Outline PG-TO 247-3, dimensions in mm/inches

600V CoolMOS™ CFD7 Power Transistor IPW60R070CFD7



7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7 Webpage: www.infineon.com

• IFX CoolMOS CFD7 application note: www.infineon.com

• IFX CoolMOS CFD7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPW60R070CFD7



Revision History

IPW60R070CFD7

Revision: 2017-12-12, Rev. 2.1

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2017-08-25	Release of final version
2.1	2017-12-12	Raised diode current for dv/dt and dif/dt (table 2) to value of continuous drain current; Changed internal Rg (table 4); Renamed related links (table 11)

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